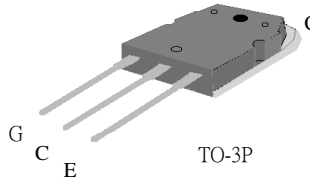


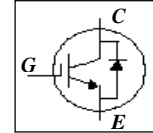


**Features**

- ▼ High Speed Switching
- ▼ Low Saturation Voltage  
 $V_{CE(sat),Typ.}=2.6V@I_C=33A$
- ▼ Built-in Fast Recovery Diode
- ▼ RoHS Compliant & Halogen-Free



$V_{CES}$	600V
$I_C$	45A



**Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
$V_{CES}$	Collector-Emitter Voltage	600	V
$V_{GE}$	Gate-Emitter Voltage	$\pm 30$	V
$I_C@T_C=25^\circ C$	Collector Current	75	A
$I_C@T_C=100^\circ C$	Collector Current	45	A
$I_{CM}$	Pulsed Collector Current	150	A
$I_F@T_C=25^\circ C$	Diode Forward Current	40	A
$I_F@T_C=100^\circ C$	Diode Forward Current	15	A
$P_D@T_C=25^\circ C$	Maximum Power Dissipation	300	W
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_J$	Operating Junction Temperature Range	150	$^\circ C$
$T_L$	Maximum Lead Temp. for Soldering Purposes , 1/8" from case for 5 seconds .	300	$^\circ C$

**Notes:**

1. Pulse width limited by max. junction temperature .

**Thermal Data**

Symbol	Parameter	Value	Units
Rthj-c	Thermal Resistance Junction-Case	0.42	$^\circ C/W$
Rthj-c(Diode)	Thermal Resistance Junction-Case	1.5	$^\circ C/W$
Rthj-a	Thermal Resistance Junction-Ambient	40	$^\circ C/W$

**Electrical Characteristics @ $T_J=25^\circ C$ (unless otherwise specified)**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$I_{GES}$	Gate-to-Emitter Leakage Current	$V_{GE}=\pm 30V, V_{CE}=0V$	-	-	$\pm 100$	nA
$I_{CES}$	Collector-Emitter Leakage Current	$V_{CE}=600V, V_{GE}=0V$	-	-	500	$\mu A$
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=33A$	-	2.6	3	V
		$V_{GE}=15V, I_C=50A$	-	3.1	3.5	V
$V_{GE(th)}$	Gate Threshold Voltage	$V_{CE}=V_{GE}, I_C=250\mu A$	2	-	6	V
$Q_g$	Total Gate Charge	$I_C=33A$	-	55	100	nC
$Q_{ge}$	Gate-Emitter Charge	$V_{CE}=400V$	-	12	-	nC
$Q_{gc}$	Gate-Collector Charge	$V_{GE}=15V$	-	27	-	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{CE}=390V,$ $I_C=33A,$	-	27	-	ns
$t_r$	Rise Time		-	22	-	ns
$t_{d(off)}$	Turn-off Delay Time	$V_{GE}=15V,$ $R_G=5\Omega,$	-	110	-	ns
$t_f$	Fall Time	Inductive Load	-	100	260	ns
$E_{on}$	Turn-On Switching Loss		-	0.7	-	mJ
$E_{off}$	Turn-Off Switching Loss		-	1.2	-	mJ
$C_{ies}$	Input Capacitance	$V_{GE}=0V$	-	1250	2000	pF
$C_{oes}$	Output Capacitance	$V_{CE}=30V$	-	235	-	pF
$C_{res}$	Reverse Transfer Capacitance	$f=1.0MHz$	-	7	-	pF
$V_F$	FRD Forward Voltage	$I_F=15A$	-	1.3	1.7	V
$t_{rr}$	FRD Reverse Recovery Time	$I_F=15A$	-	65	-	ns
$Q_{rr}$	FRD Reverse Recovery Charge	$di/dt = 200 A/\mu s$	-	230	-	nC

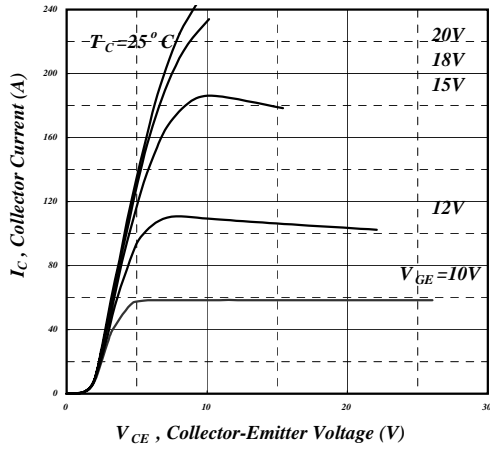


Fig 1. Typical Output Characteristics

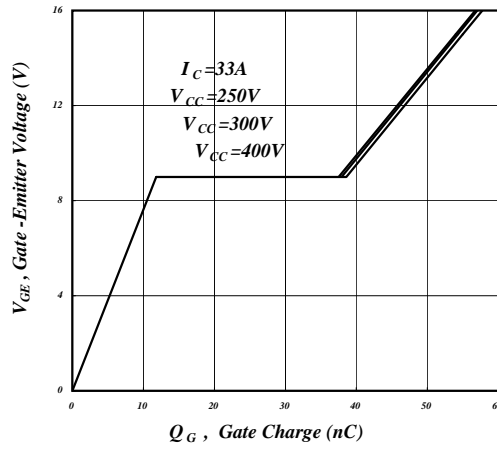


Fig 2. Gate Charge Characteristics

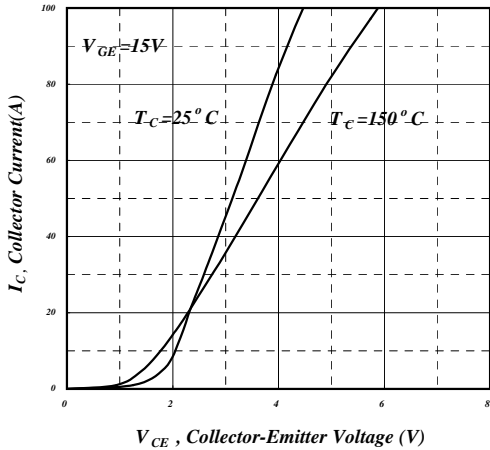


Fig 3. Typical Saturation Voltage Characteristics

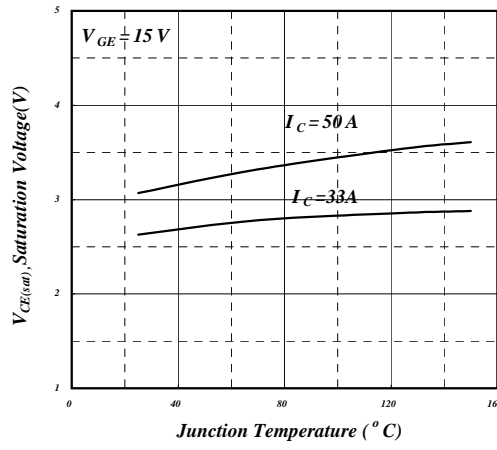


Fig 4. Typical Collector- Emitter Voltage v.s. Junction Temperature

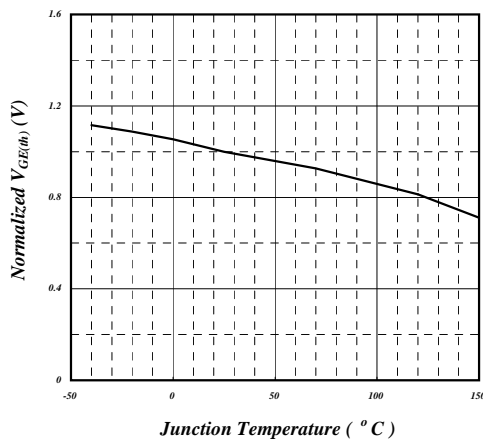


Fig 5. Gate Threshold Voltage v.s. Junction Temperature

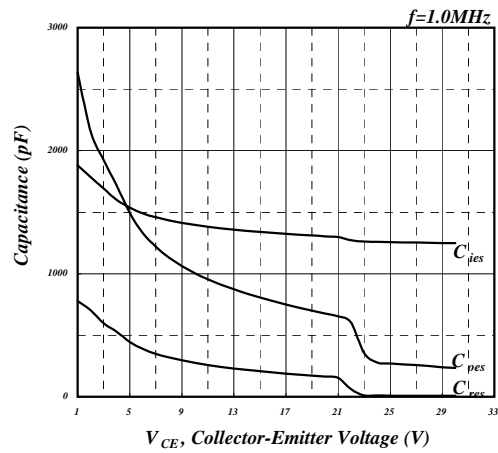


Fig 6. Typical Capacitance Characteristics

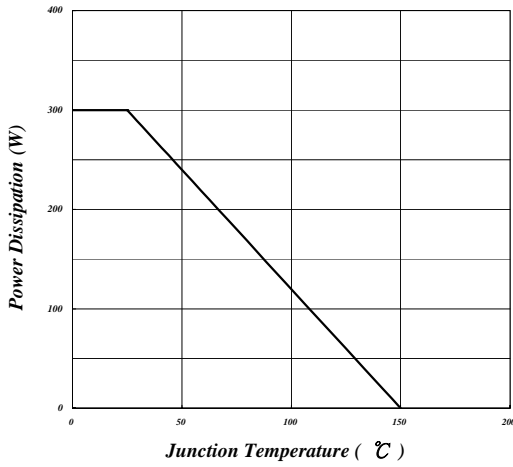


Fig 7. Power Dissipation vs. Junction Temperature

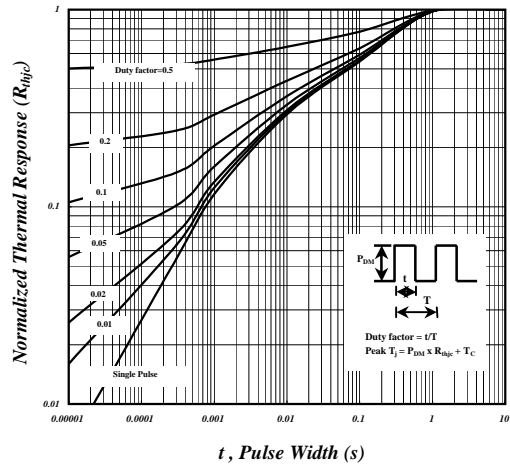


Fig 8. Effective Transient Thermal Impedance, Junction-to-Case (IGBT)

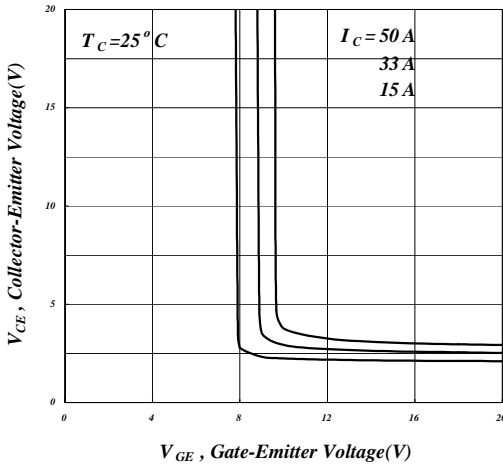


Fig 9. Saturation Voltage vs. V<sub>GE</sub>

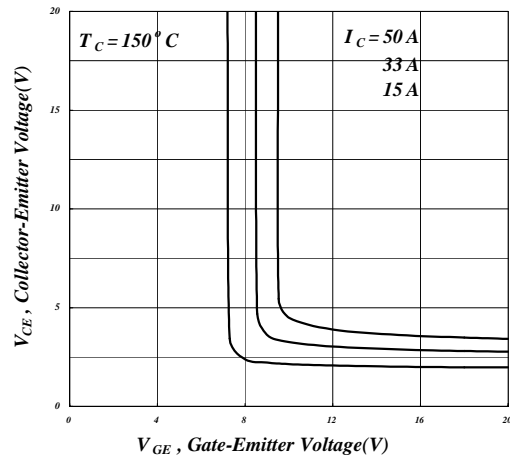


Fig 10. Saturation Voltage vs. V<sub>GE</sub>

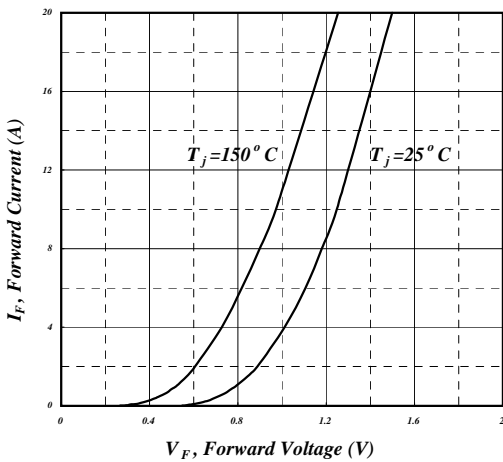


Fig 11. Forward Characteristic of Diode

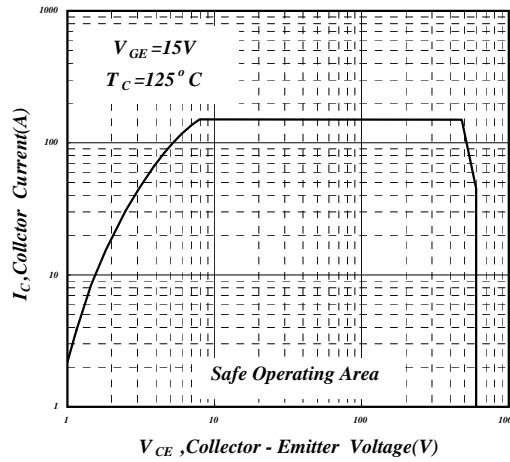


Fig 12. SOA Characteristics